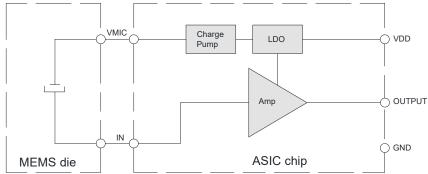


Description

The MA-HRA381-H23-5A is a small package, high SNR and analog output bottom port MEMS microphone, consists of a MEMS sensor and a low noise level ASIC.



Top View Bottom View

Fig. 1 Microphone block diagram

Key Features

- 3.5x2.65x0.98mm Bottom Port
- High SNR
- Narrow Sensitivity +/-1dB
- LFRO<15Hz
- RF Shielded
- Compatible with Standard SMD Reflow Technology
- RoHS Compliance & Halogen Free

Typical Applications

- Mobilephones
- TWS Earphone
- Wireless Headsets
- **Smart Speakers**
- Wearable Electronics
- **Smart Home Electronics**
- Automotive

Maximum Ratings

Stresses at the maximum ratings shown in Table 1 may cause permanent damage to the device. These are stress ratings only at which the device may not function when an operation at these or any other condition beyond those specified under "Electro-Acoustic Specifications".

Table 1 Maximum Ratings

Parameter	Maximum Ratings	Unit
Supply voltage	3.6	V
Supply current	1	mA
Output current	1	mA
Operation temperature range	-40~100	${\mathbb C}$
Storage temperature range	-40~100	${\mathbb C}$



Electro-Acoustic Specifications

Table 2 Electrical Specifications

Test condition: +25±2°C, 60%~70% RH, 86~106Kpa, Vdd=2V, no load, unless otherwise specified.

No.	Parameter	Symbol	Condition	Min.	Nom.	Max.	Unit
1	Sensitivity	S	f=1KHz, Pin=1Pa, 0dB=1V/Pa	-39	-38	-37	dB
2	Operating Voltage	V _{DD}		1.6	2	3.3	V
3	Directivity			Omni-d	irectiona	I	
4	Polarity		Sound pressure increase	Output	voltage i	ncrease	
5	Sensitivity vs. Voltage	ΔS	Vs= 1.6V to 3.3V	<0.5			dB
6	Output Impedance	Z _{OUT}	f=1KHz			400	Ω
7	Current Consumption	I	1.6V to 3.3V		85	200	μΑ
	S/N Ratio		20-5KHz Bandwidth, A- Weighted		68		dBA
8		S/N	20-8KHz Bandwidth, A- Weighted		67		dBA
			20-20KHz Bandwidth, A- Weighted	64	66		dBA
9	Total Harmonic	THD	94dB SPL @1KHz		0.10	0.5	%
9	Distortion		114dBSPL @1KHz		1		70
10	Acoustic Overload Point	AOP	THD 10%@1KHz		124		dBSPL
11	Power Supply Rejection	PSR	100mVpp Squarewave @217Hz, Vdd=2.0V, A-weighted		-99	-90	dB
12	Power Supply Rejection Ratio	PSRR	200mVpp Sinewave @1KHz	60	72		dB
13	DC output	VDC			0.85		V
	Output load	C _{load}				150	pF
14		R _{load}		10		100	ΚΩ

Note: Frequency response, sensitivity and current consumption are tested by 100% on product line.



Performance Curves

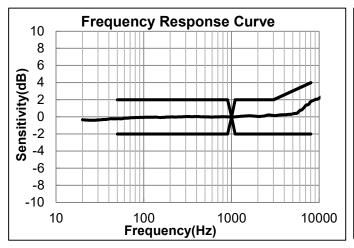


Fig.2 Frequency response curve normalized to 1KHz

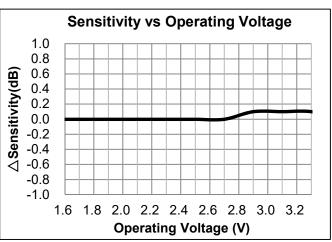


Fig. 3 Sensitivity vs Operating Voltage

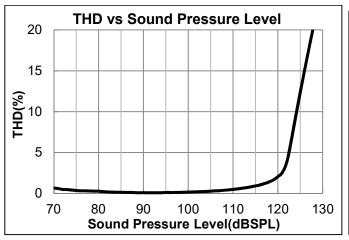


Fig. 4 Typical THD vs Sound Pressure Level

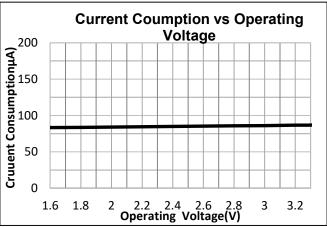


Fig. 5 Typical Current vs Operating Voltage

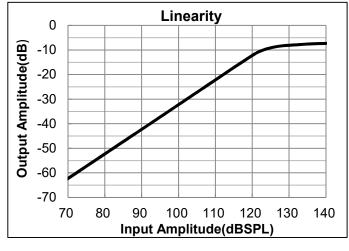


Fig. 6 Linearity

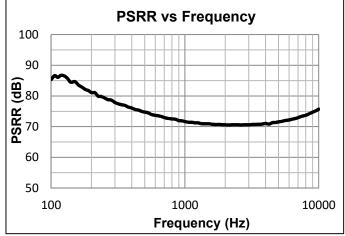


Fig. 7 Typical PSRR curve



Measurement System Setup

Test signal: Sinusoid, Sweep,

Step: 1/12 octave

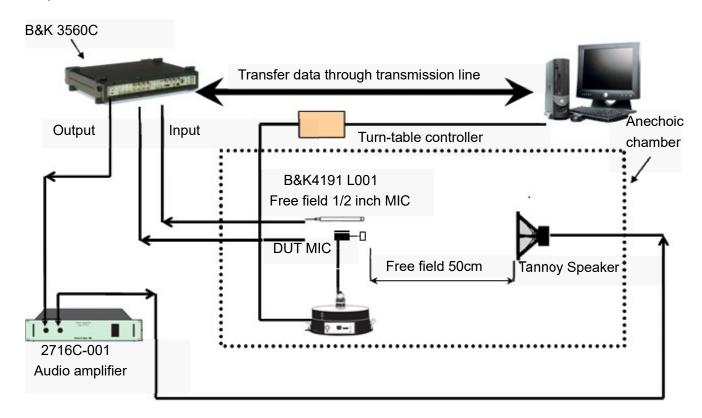


Fig. 8 Measurement System Setup



Typical Application Circuit

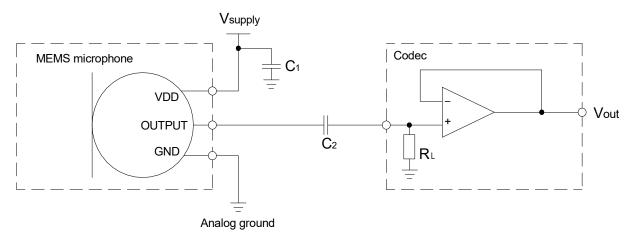


Fig. 9 Typical Application Circuit

Power supply decoupling:

A 0.1uF ceramic type decoupling capacitor C₁ is strongly recommended for every microphone and it should be placed as close to the VDD pad to reduce the noise on power supply;

The trace connected to each pad of capacitor should be as short as possible, and should stay on one layer of PCB without via. For the best performance, recommend to place the capacitor equidistance from power and ground pins of microphone, or slightly closer to the power pin if space not allowed. System ground should connect to far side of the capacitor, as shown in fig.10.

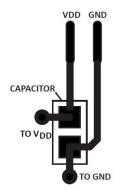


Fig. 10 Recommended Power Supply Decoupling Capacitor Layout

Low frequency roll-off:

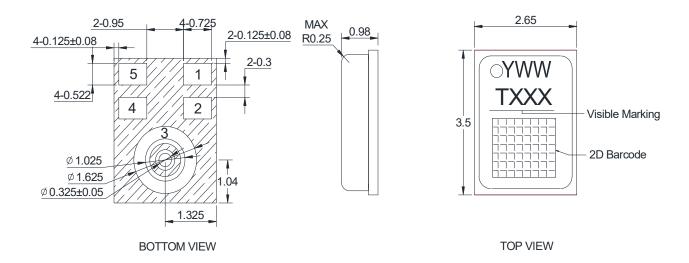
DC-blocking capacitor C_2 is required on the output signal line. The 3-dB cut-off frequency can be calculated using follow equation which is related to DC-blocking capacitor C_2 and input resistance of the amplifier.

3dB cut-off frequency=1/2πR_LC₂

In order to get a cut-off frequency below 20 Hz, minimum 1uF value of C_2 and minimum 20K Ω value of input resistance of the amplifier is recommended.



Mechanical Specifications



Unit: mm Unmarked Tolerance: ± 0.1 (mm)

Fig. 11 Dimension

Item	Dimension	Tolerance
Length	3.50	±0.1
Width	2.65	±0.1
Height	0.98	±0.1
Acoustic Port	0.325	±0.05

PIN	Definition	Description
1	OUT	Output
2	GND	Ground
3	GND	Ground
4	GND	Ground
5	VDD	Power Supply

Note:

- All Ground Pin must be connected to the ground in end application
- Identification Marking
 - o: Polarity sign Y: Year WW: Week
 - T: GETTOP XXX: Serial Number
 - 2D Barcode



Reliability Specifications

After conducting any of the following tests, the sensitivity change of DUT shall be less than ±3dB from its initial value unless otherwise noted, and shall keep its initial operation and appearance.

Table 3 Reliability Specifications

No.	Item	Test condition	
		24 hour bake at 125°C, followed by 168 hours at 85°C, 85%RH,	
		followed by 3 passes solder reflow	
	Due a condition in a	only for the following three tests:	
1	Preconditioning	6. High Humidity &High Heat operating Test	
		7. High Humidity &High Heat operating Test	
		8.Thermal Shocking Test	
2	Hi-Temperature Storage Test	105±3℃,1000h,recover for two hours	
3	Hi-Temperature operating Test	105±3℃, under upper limit bias,1000h, recover for two hours	
4	Low-Temperature storage Test	-40±3°C,1000h, recover for two hours	
5	Low-Temperature operating Test	-40±3℃, under upper limit bias,1000h,recover for two hours	
	High Humidity 9 High Hoot	85±3℃, 85%RH, under upper limit bias, 1000h,recover for two	
6	High Humidity &High Heat operating Test	hours, there should be no corrosion and deformation inside of	
		microphone after testing	
	High Humidity &High Heat operating Test	65±3℃, 95%RH, under upper limit bias, 168h,recover for two	
7		hours ,there should be no corrosion and deformation inside of	
		microphone after testing	
8	Thermal Shocking Test	Double-Case Method, -40°C for 15mins \rightarrow 125°C for 15 mins, 100	
	Thermal encoking rest	cycles, recover for two hours	
9	Vibration Test	Each 12mins for X, Y and Z axes, Frequency: 20~2000Hz,	
	VIDIGUOTI TOOL	Peak Acceleration 20g, recover for two hours	
		Height:1.5m	
		Fixture Weight:150g	
10	Drop Test	(Sound Hole Diameter in the fixture is >=0.8mm)	
		Reference Surface: slippery marble floor	
		Duration:4 corners*4 times, 6 faces*4 times	
		The sensitivity change should be less than 1dB after testing	
		Height:1.0m	
		Fixture Weight:150g	
11	Tumbling Test	(Sound Hole Diameter in the fixture is >=0.8mm)	
		Duration: 300 times	
		Recommended Time: 10-11times/Min	
		The sensitivity change should be less than 1dB after testing	





12	ESD Test 1	 a. HMB Discharge Position: I/O pins Charge Voltage: ±3000V Discharge Network: 100pF & 1500Ω b. CDM Discharge Position: I/O pins Charge Voltage: ±250V 		
13	B ESD Test 2	The tests are performed acc. to IEC61000-4-2 level 3: a. Contact Discharge Discharge Position: Output of Microphone Charge Voltage:±6000VDC Discharge Network:150pF & 330Ω b. Air Discharge Discharge Position: Sound Hole Charge Voltage:±8000VDC Discharge Network:150pF & 330Ω		
14	Structure Shock Test	10000g, Duration: 0.1ms, each 3 shocks for X/Y/Z 3 axes, The sensitivity change should be less than 1dB after testing		
15	5 Reflow	3 reflow cycles with peak temperature of +260°C according to reflow profile		



Packaging Details

- * Use ESD reel and tape for microphone packaging.
- * Anti-static measures should be applied during packaging operation.

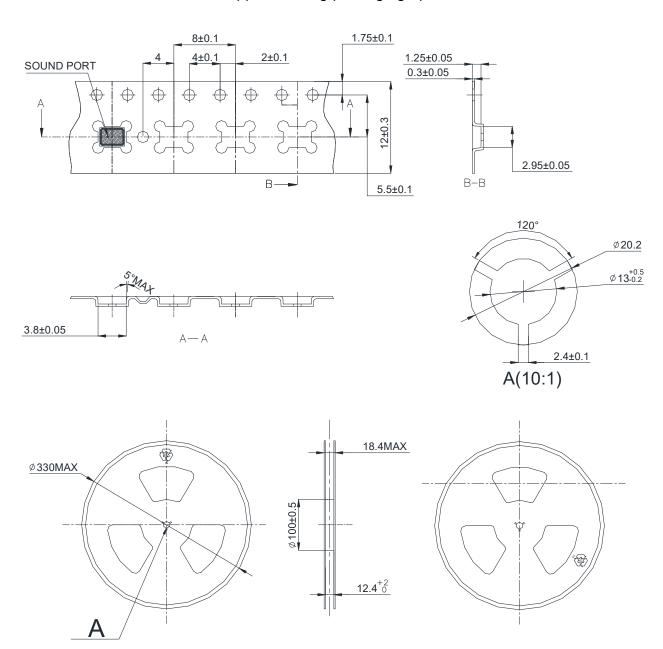
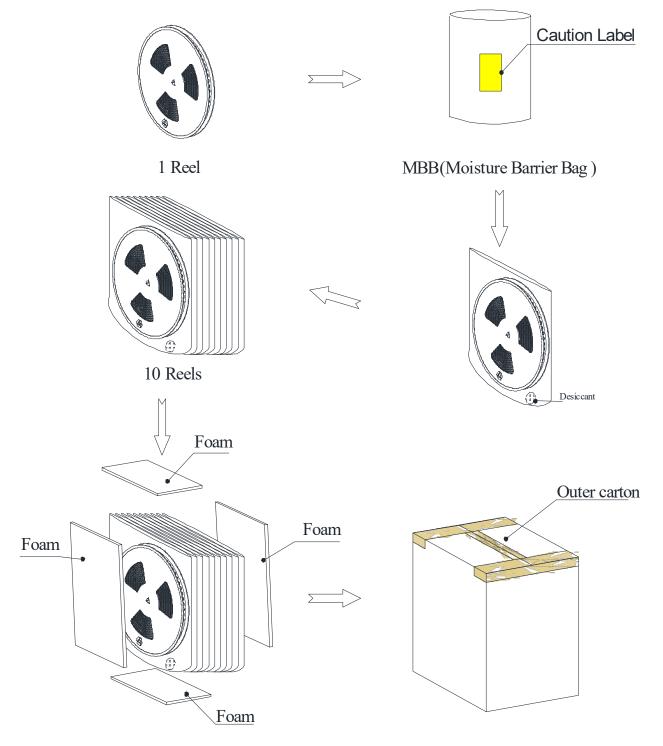


Fig. 12 Packaging



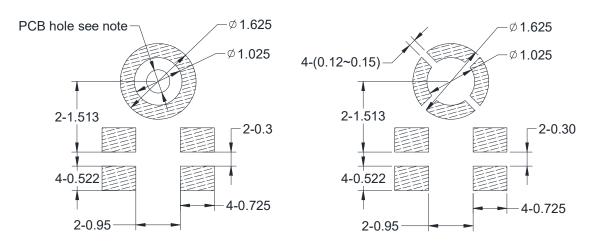


Tape and Reel	φ330mm	5,500PCS×1=5,500PCS
Shipping Box	215mm*370mm*370mm	5,500PCS×10=55,000PCS



Application Design Suggestions

Recommended PCB and Stencil Design Pattern



Example Land Pattern

Example Solder Stencil Pattern

Notes:

- Dimensions are in millimeters unless otherwise specified.
- Tolerance is ± 0.1 mm unless otherwise specified.
- The recommended non-plated hole diameter of PCB is 0.4-0.8mm.

Temperature Profile during Reflow Process

Table 4 Temperature Profile during Reflow Process

Parameter		Reference	Specification
Average Ramp Rate		T _L to T _P	3°C/sec max
	Minimum Temperature	T _{SMIN}	150°C
Preheat	Maximum Temperature	T _{SMAX}	200°C
	Time T _{SMIN} to T _{SMAX}	ts	60 sec to 180 sec
Ramp-Up Rate		T _{SMAX} to T _L	1.25°C/sec
Time Maintained Above Liquidous		t _L	60 sec to 150 sec
Liquidous Temperature		T _L	217°C
Peak Temperature		T _P	260°C
Time Within +5°C of Actual Peak Temperature		t _P	20 sec to 40 sec
Ramp-Down Rate		T _P to T _{SMAX}	6°C/sec max
Time +25°C (t25°C) to Peak Temperature			8 min max

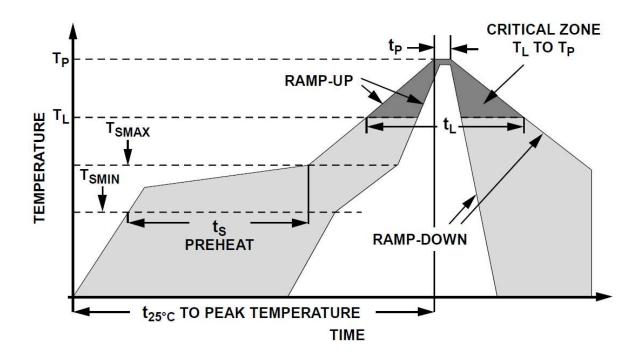


Fig. 13 Reflow Profile

Additional Notes:

- After the initial reflow, the MIC shall be resumed to room temperature if more reflow is needed.
- No more than 3 times reflow is recommended.
- Do not board wash by liquid or ultrasonic after the reflow process.
- Do not pull a vacuum over port hole of the microphone.
- Do not insert any object in port hole of device at any time.
- Suggest SMT the microphone at last time if double side PCBA used.
- Do not seal sound port during reflow .
- If there is any leakage risk, the peak temperature should be set to less than 240°C or more than 255°C.



Recommended nozzle for reflow MIC

External diameter is Φ1.8mm Inside diameter is Φ1.2mm

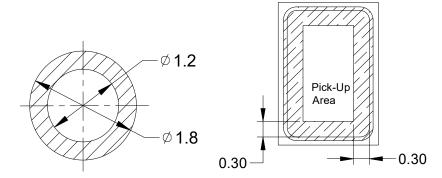


Fig. 14 Recommended nozzle for reflow MIC and Pick-up Area

Special Cautions

Air Rifle Cleaning Restriction

Do not bring air rifle to the port hole directly.

Recommended Condition:

Air pressure < 0.3MPa;

Distance>5cm;

Time<5 sec

Package

Do not store the remained material with the vacuum seal static bags.

Storage

The component needs to meet the requirement of MSL(Moisture Sensitivity Level) class 1. Please keep MICs in warehouse with humidity less than 75% and without sudden temperature change, acid air, and any other harmful air or strong magnetic field.

Please protect products against moist, shock, sunburn and pressure.

Please take proper measures against ESD in the process of assembly and transportation.

Please use the shipping package for long-term storage.

Discard

For microphones to be wasted, customer shall follow the regulation of Waste Electrical and Electronic Equipment (WEEE) Directive (2002/96/EC).

Notes: More application suggestions can be found in the latest "MEMS Microphone Application Notes".



Specification Revisions

Date	Version	Description
08-27-2024	V1.0	Initial Release
10-31-2024	V2.0	Add typical application of automotive
01-02-2025	V3.0	Updated operating voltage range and packaging details
01-10-2025	V4.0	Updated packaging details